

IGBT

SGL160N60UFD

Ultra-Fast IGBT

General Description

Fairchild's UFD series of Insulated Gate Bipolar Transistors (IGBTs) provides low conduction and switching losses. The UFD series is designed for applications such as motor control and general inverters where high speed switching is a required feature.

Features

- High speed switching
- Low saturation voltage: V_{CE}(sat) = 2.1 V @ I_C = 80A
- · High input impedance
- CO-PAK, IGBT with FRD: t_{rr} = 75nS (typ.)

Applications

AC & DC motor controls, general purpose inverters, robotics, servo controls, and power supplies.





Absolute Maximum Ratings $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Description		SGL160N60UFD	Units	
V _{CES}	Collector-Emitter Voltage		600	V	
V _{GES}	Gate-Emitter Voltage		± 20	V	
	Collector Current	@ T _C = 25°C	160	Α	
I _C	Collector Current	@ T _C = 100°C	80	Α	
I _{CM (1)}	Pulsed Collector Current		300	Α	
I _F	Diode Continuous Forward Current	@ T _C =100°C	25	Α	
I _{FM}	Diode Maximum Forward Current		280	Α	
P_{D}	Maximum Power Dissipation	@ $T_C = 25^{\circ}C$	250	W	
	Maximum Power Dissipation	@ T _C = 100°C	100	W	
TJ	Operating Junction Temperature		-55 to +150	°C	
T _{stg}	Storage Temperature Range		-55 to +150	°C	
T _L	Maximum Lead Temp. for Soldering Purposes, 1/8" from Case for 5 Secon	ds	300	°C	

Notes:(1) Repetitive rating: Pulse width limited by max. junction temperature

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Units
$R_{\theta JC}(IGBT)$	Thermal Resistance, Junction-to-Case		0.5	°C/W
$R_{\theta JC}(DIODE)$	Thermal Resistance, Junction-to-Case		0.83	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		25	°C/W

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Off Chai	racteristics					
BV _{CES}	Collector-Emitter Breakdown Voltage	$V_{GE} = 0V, I_{C} = 250uA$	600			V
$\Delta B_{VCES}/$ ΔT_J	Temperature Coefficient of Breakdown Voltage	$V_{GE} = 0V$, $I_C = 1mA$		0.6		V/°C
I _{CES}	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0V$			250	uA
I _{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0V$			± 100	nA
On Char	acteristics					
V _{GE(th)}	G-E Threshold Voltage	$I_C = 80$ mA, $V_{CE} = V_{GE}$	3.5	4.5	6.5	V
	Collector to Emitter	I _C = 80A, V _{GE} = 15V		2.1	2.6	V
$V_{CE(sat)}$	Saturation Voltage	I _C = 160A, V _{GE} = 15V		2.6		V
•	C Characteristics Input Capacitance	I		5000		pF
C _{ies}	· · · · · · · · · · · · · · · · · · ·	$V_{CE} = 30V_{V_{GE}} = 0V_{V_{CE}}$				-
C _{oes} C _{res}	Output Capacitance Reverse Transfer Capacitance	f = 1MHz		600 200		pF pF
	ng Characteristics	T		40		nc
t _{d(on)}	Turn-On Delay Time Rise Time	-		40		ns
t _r	Turn-Off Delay Time			101 90	130	ns ns
t _{d(off)} t _f	Fall Time	$V_{CC} = 300 \text{ V}, I_{C} = 80\text{A},$ $R_{G} = 3.9\Omega, V_{GE} = 15\text{V}$		75	150	ns
E _{on}	Turn-On Switching Loss	Inductive Load, T _C = 25°C		2500		uJ
E _{off}	Turn-Off Switching Loss	-		1760		uJ
E _{ts}	Total Switching Loss	1		4260	5000	uJ
t _{d(on)}	Turn-On Delay Time			45		ns
t _r	Rise Time	1		105		ns
t _{d(off)}	Turn-Off Delay Time	$V_{CC} = 300 \text{ V}, I_{C} = 80\text{A},$		140	200	ns
t _f	Fall Time	$R_G = 3.9\Omega, V_{GE} = 15V$		122	250	ns
E _{on}	Turn-On Switching Loss	Inductive Load, T _C = 125°C		2785		uJ
E _{off}	Turn-Off Switching Loss			3100		uJ
E _{ts}	Total Switching Loss			5885		uJ
Q_g	Total Gate Charge	$V_{CE} = 300 \text{ V}, I_{C} = 80\text{A},$		345	520	nC
Q _{ge}	Gate-Emitter Charge	$V_{GE} = 000 \text{ V}, 10 = 007 \text{ V}, 10 = 007 \text{ V}$		60	100	nC
Q _{gc}	Gate-Collector Charge			95	150	nC
L _e	Internal Emitter Inductance	Measured 5mm from PKG		18		nH

Electrical Characteristics of DIODE $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Units
V	Diode Forward Voltage	I _E = 25A	$T_C = 25^{\circ}C$		1.4	1.7	V
V_{FM}	Diode Forward Voltage	IF = 25A	T _C = 100°C		1.3		1 V
+	t _{rr} Diode Reverse Recovery Time		$T_C = 25^{\circ}C$		50	75	ns
^t rr			T _C = 100°C		105		
	Diode Peak Reverse Recovery	I _F = 25A, di/ dt = 200 A/us	$T_C = 25^{\circ}C$		4.5	10	۸
^I rr	Current		T _C = 100°C		8.5		A
	Q _{rr} Diode Reverse Recovery Charge		$T_C = 25^{\circ}C$		112	375	nC
Q _{rr}			T _C = 100°C		420		IIC

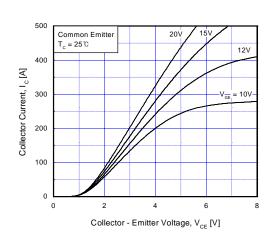


Fig 1. Typical Output Characteristics

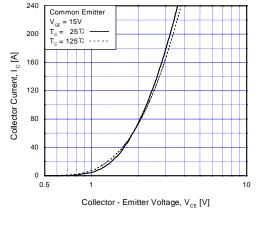


Fig 2. Typical Saturation Voltage Characteristics

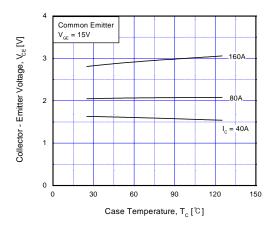


Fig 3. Saturation Voltage vs. Case Temperature at Variant Current Level

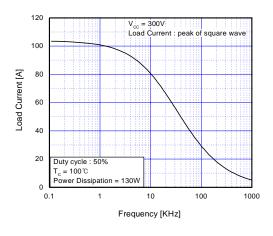


Fig 4. Load Current vs. Frequency

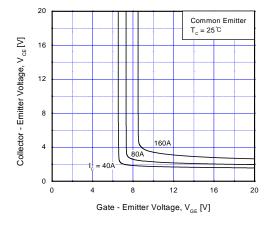


Fig 6. Saturation Voltage vs. V_{GE}

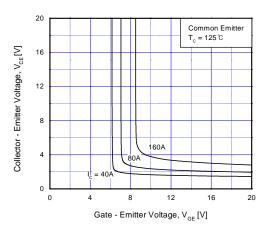


Fig 7. Saturation Voltage vs. $V_{\rm GE}$

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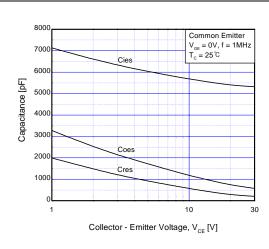
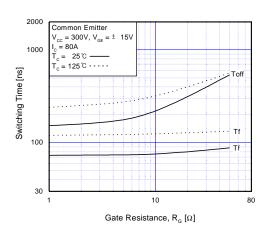


Fig 7. Capacitance Characteristics

Fig 8. Turn-On Characteristics vs.
Gate Resistance



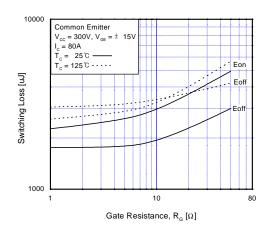
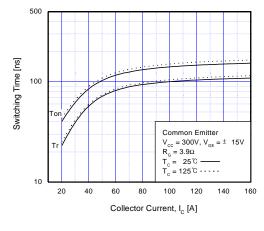


Fig 9. Turn-Off Characteristics vs.
Gate Resistance

Fig 10. Switching Loss vs. Gate Resistance



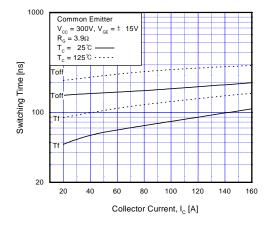
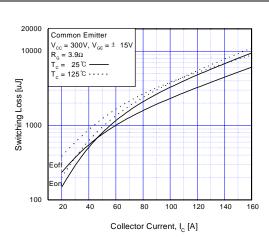


Fig 11. Turn-On Characteristics vs. Collector Current

Fig 12. Turn-Off Characteristics vs.
Collector Current



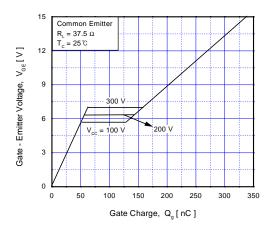
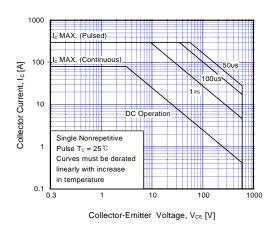


Fig 13. Switching Loss vs. Collector Current

Fig 14. Gate Charge Characteristics



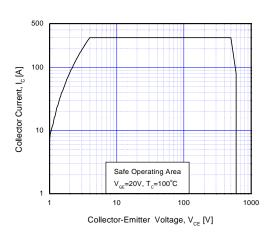


Fig 15. SOA Characteristic

Fig 16. Turn-Off SOA Characteristics

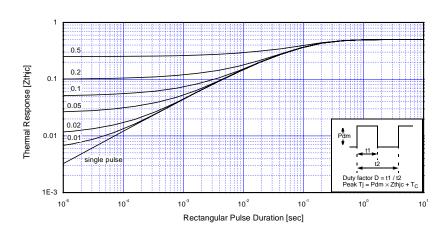
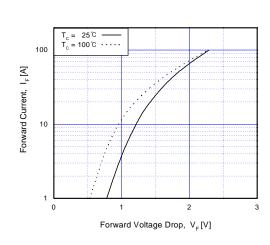


Fig 17. Transient Thermal Impedance of IGBT

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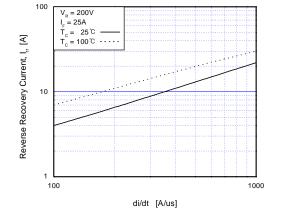
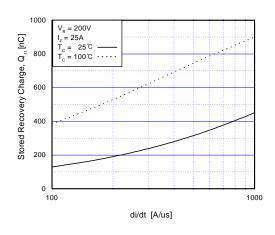


Fig 18. Forward Characteristics

Fig 19. Reverse Recovery Current

100



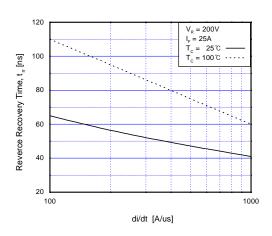
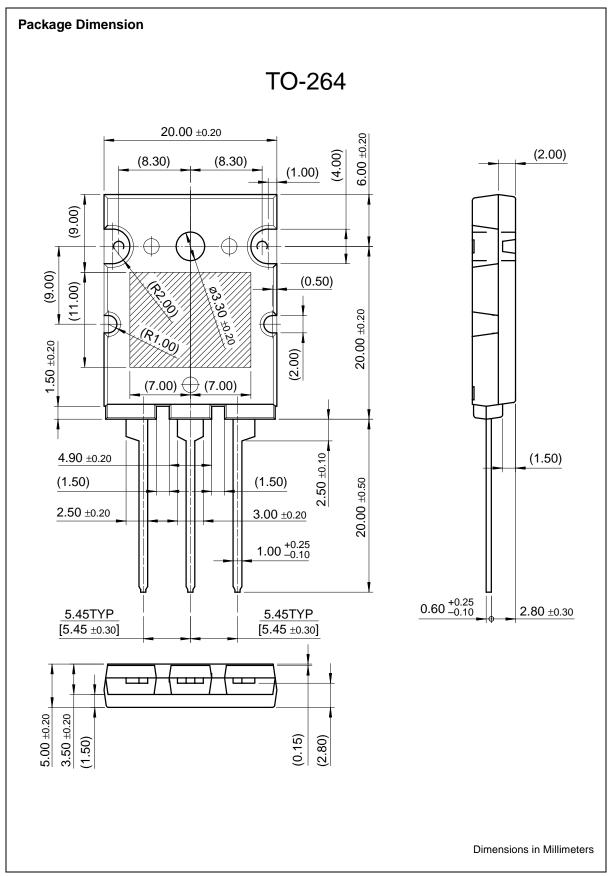


Fig 20. Stored Charge

Fig 21. Reverse Recovery Time



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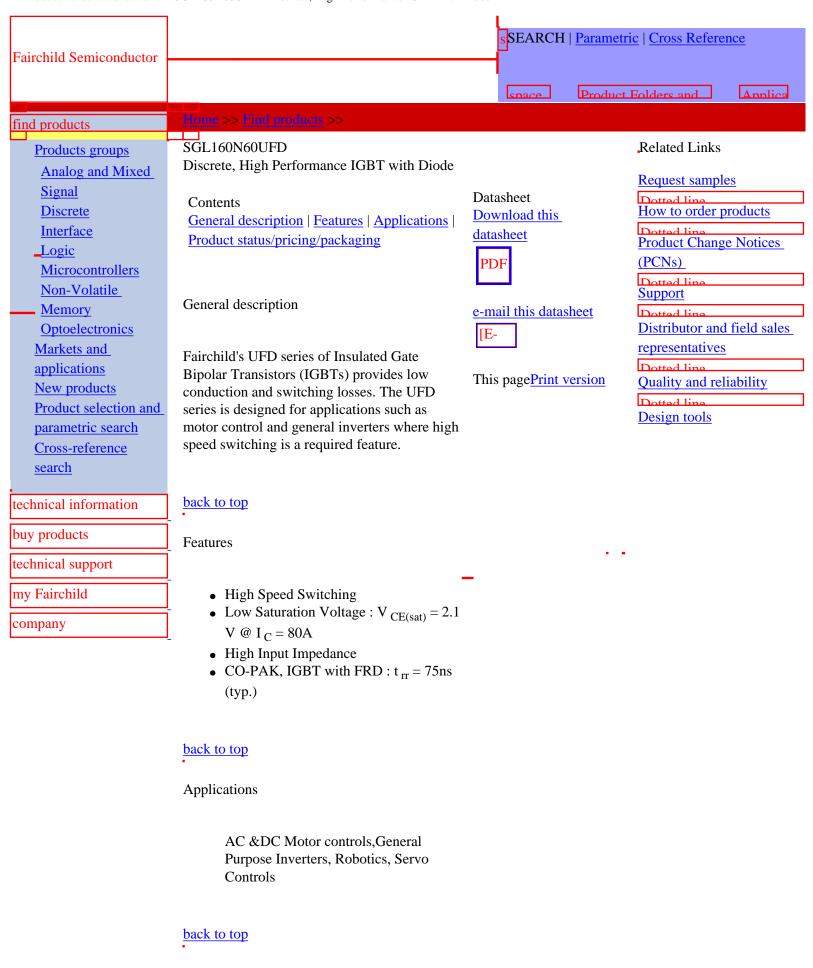
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Product status/pricing/packaging



Product	Product status	Pricing*	Package type	Leads	Packing method
SGL160N60UFDTU	Full Production	\$12.73	<u>TO-264</u>	3	RAIL

^{* 1,000} piece Budgetary Pricing

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